



a HEICO company

Product Change Notice

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QMS Approval n° 9910354

Product Change Notice #: 007

Date: 15th Oct 2011

Title of Change: Standardize Module Case to Ground

Type Of Change

- | | |
|---|---|
| <input type="checkbox"/> Manufacturing Site Change | <input type="checkbox"/> Shipping / Packaging Material Change |
| <input type="checkbox"/> Manufacturing Process Change | <input type="checkbox"/> Packing / Label / Marking Change |
| <input type="checkbox"/> Product Revision | <input type="checkbox"/> Product End Of Life (EOL) |
| <input type="checkbox"/> Material Change | <input checked="" type="checkbox"/> Data Sheet Change |

Description of Change

The case of 3D Plus catalog space qualified modules is systematically tied to the modules' electrical Ground pin (GND) for modules with Date Code DC1145 or after. The part number of the modules will stay the same.

Reason for Change

In order to avoid floating metal area, the case of the catalog space qualified modules' was tied to the electrical ground pin by the customers during the module' assembly process.
This feature is now systematically done by 3D Plus at module's package level during the modules' manufacturing process. It will simplify the customer integration process. Also, it standardizes all catalog space qualified memory modules in term of connecting Case to Ground.

Contact Information

Marketing and Engineering Contact

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Product Affected

3D Plus Hi-Rel Memory Products

3D PLUS Sites Affected

- | | |
|---|---|
| <input checked="" type="checkbox"/> 3D PLUS Buc High Rel. | <input type="checkbox"/> 3D PLUS Buc Indus. |
|---|---|

Coming into force

PCN Coming into force: Immediate effect